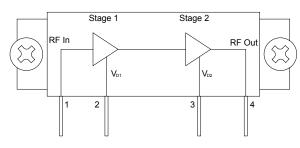


## **Product Description**

The **XD010-04S-D4F** 10W power module is a robust broadband 2-stage Class A/AB amplifier, suitable for use as a power amplifier driver or output stage. It is a drop-in, no-tune, solution for high power applications requiring high efficiency, excellent linearity, and unit to unit repeatability. Internal bias current compensation ensures stable performance over a wide temperature range.

#### **Functional Block Diagram**



Case Flange = Ground

# XD010-04S-D4F

350-600 MHz Class AB 10W Power Amplifier Module



## **Product Features**

- 50 Ω RF Impedance
- > 10W Output P<sub>1dB</sub>
- Single Voltage Operation
- High Gain: 32 dB Typical
- Temperature Compensation
- Robust 8000V ESD (HBM), Class 3B

## **Applications**

- DTV
- Public Service
- Wireless Infrastructure
- Military
- CDMA or GSM

## **Key Specifications**

| Parameter        | Test Conditions: $Z_{in} = Z_{out} = 50\Omega$ , $V_D = 28.0V$ , $I_{D1} = 230$ mA, $I_{D2} = 150$ mA, $T_{Flange} = 25$ °C | Unit | Min. | Тур. | Max. |
|------------------|---|------|------|------|------|
| Frequency        | Frequency of Operation  | MHz  | 350  | -    | 600  |
| P <sub>1dB</sub> | Output Power at 1dB Compression, 450MHz   | W    | -    | 12   | -    |
| Gain             | Gain at 10W Output Power, 450MHz  | dB   | 30   | 32   | -    |
| Gain Flatness    | Peak to Peak Gain Variation, 350 - 600MHz   | dB   | -    | 1.0  | 2.0  |
| IRL              | Input Return Loss 1W Output Power, 350 - 600MHz   | dB   | 10   | 15   | -    |
| Efficiency       | Drain Efficiency at 10W CW, 350-600MHz  | %    | 26   | 30   | -    |
| Linearity        | 3 <sup>rd</sup> Order IMD at 10W PEP (Two Tone), 450MHz & 451MHz  | dBc  | -    | -32  | -28  |
| Delay            | Signal Delay from Pin 1 to Pin 4  | nS   | -    | 2.5  | -    |
| Phase Linearity  | Deviation from Linear Phase (Peak to Peak)  | Deg  | -    | 0.5  | -    |

#### **Quality Specifications**

| Parameter            |  | Unit | Min  | Typical               | Max |
|----------------------|--|------|------|-----------------------|-----|
| ESD Rating           | Human Body Model, JEDEC Document - JESD22-A114-B | V    | 8000 | -                     | -   |
| MTTF                 | 85°C Baseplate, 200°C Channel                    | Н    | -    | 1.2 X 10 <sup>6</sup> | -   |
| R <sub>TH, j-l</sub> | Thermal Resistance Stage 1 (Junction to Case)    | °C/W | -    | 11                    | -   |
| R <sub>TH, j-2</sub> | Thermal Resistance Stage 2 (Junction to Case)    | °C/W | 1    | 4                     | 1   |

The information provided herein is believed to be reliable at press time. Sirenza Microdevices assumes no responsibility for inaccuracies or ommisions.

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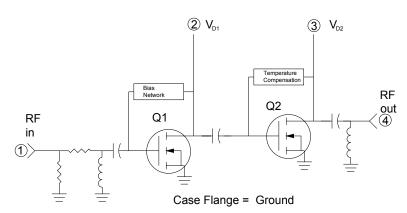


### XD010-04S-D4F 350-600 MHz 10W Amp

#### **Pin Description**

| Pin#   | Function        | Comments   |
|--------|-----------------|--|
| 1      | RF Input        | Internally connected to DC ground. Do not apply DC voltages to the RF leads.   |
| 2      | $V_{D1}$        | 1 <sup>st</sup> stage bias   |
| 3      | V <sub>D2</sub> | 2 <sup>nd</sup> stage bias. Integrated temperature compensation maintains constant current over the operating temperature range. See Note 1.   |
| 4      | RF Output       | Internally connected to DC ground. Do not apply DC voltages to the RF leads.   |
| Flange | Gnd             | Baseplate provides electrical ground and a thermal transfer path for the device. Proper mounting assures optimal performance and the highest reliablility. See Sirenza applications note: AN-060 Installation Instructions for XD Module Series. |

#### **Simplified Device Schematic**



#### **Absolute Maximum Ratings**

| / woodate maximum rtatinge                            |             |      |  |  |  |
|---|-------------|------|--|--|--|
| Parameters  | Value       | Unit |  |  |  |
| 1 <sup>st</sup> Stage Bias Voltage (V <sub>D1</sub> ) | 35          | V    |  |  |  |
| 2 <sup>nd</sup> Stage Bias Voltage (V <sub>D2</sub> ) | 35          | V    |  |  |  |
| RF Input Power  | +20         | dBm  |  |  |  |
| Load VSWR for Continuous Operation Without Damage     | 5:1         | VSWR |  |  |  |
| Device Channel Temperature                            | +200        | °C   |  |  |  |
| Lead Temperature During Solder Reflow                 | +210        | °C   |  |  |  |
| Operating Temperature Range                           | -20 to +90  | °C   |  |  |  |
| Storage Temperature Range                             | -40 to +100 | °C   |  |  |  |

Operation of this device beyond any one of these limits may cause permanent damage. For reliable continuous operation refer to the key specifications table on the first page of the datasheet.

#### Note 1:

The internally generated gate voltage is thermally compensated to maintain constant drain quiescent current over the temperature range listed in the data sheet. No compensation is provided for gain changes with temperature. This can only be provided with an external AGC circuit.

#### Note 2:

Internal RF decoupling is included on all bias leads. No additional bypass elements are required, however some applications may require energy storage on the  $\rm V_{\rm D}$  leads to accommodate modulated signals.



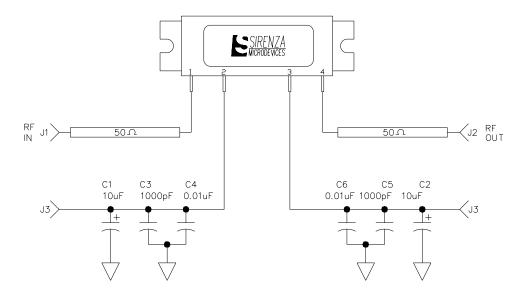
#### **Caution: ESD Sensitive**

Appropriate precautions in handling, packaging and testing devices must be observed.

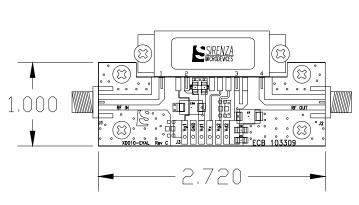




#### Test Board Schematic with module attachments shown



### **Test Board Layout and Bill of Materials**



| Component          | Description   | Manufacturer |  |
|--------------------|---|--------------|--|
| PCB                | Rogers 4350, $\varepsilon_r$ =3.5<br>Thickness=30mils             | Rogers       |  |
| J1, J2             | SMA, RF, PCB Mount Tab<br>W / Flange                              | Johnson      |  |
| J3                 | MTA Post Header, 6 Pin,<br>Rectangle, Polarized,<br>Surface Mount | AMP          |  |
| C1, C2             | Cap, 10 $\mu$ F 50V, 10%,<br>Tant, D                              | Kemet        |  |
| C4, C6             | Cap, 0.01 $\mu$ F, 100V, 10%, 1206                                | Johanson     |  |
| C3, C5             | Cap, 1000pF, 100V, 10%, 1206                                      | Johanson     |  |
| Mounting<br>Screws | 4-40 X 0.250"   | Various      |  |
| Colews             |   |              |  |

Gerber files, DXF drawings, a detailed BOM, and assembly recommendations for the test board with fixture are available from Sirenza applications.

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